ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	C omposition De 2005. IPC, Bannock and Pan-American c	claration burn, Illinois. A opyright conven	ll rights reserved utions.	under both This level	documer parts, th	nt is a declaration e declaration er	on of the substancompasses all	nces within lower level	the manufactur materials for w	rer listed ite hich the ma	m. Note: if	the item is an as has engineering	sembly with low responsibility.
				Form Type * Distribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information							
upplier Information													
Company name* Company unique ID					U	Unique ID Authority Response Date*							
onsemi						2025-06-05							
Contact Name Title			et	Phone - Cor			act*			Email - C	Email - Contact*		
Product-Env-Stewards	Product Enviro Compliance			N	NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title			entative	ve Phone - Representative			entative*	ive* Email			nail - Representative*		
Product-Env-Stewards Pro			ro Compliance		N	NA Product-Env-Stewards@onsemi.com					m		
Requester Item Number Mfr Iten		Number Mfr Item Name]	Effective Date	Version	Manufa	Manufacturing Site		eight*	UOM	Unit Type	
	NXH80 P1G	1800A100L4Q2F2 Mass market Gen3 Q2 Press-fit PIN		13 Q2PACK Positive	with	2025-06-05		CNG	CNG		75612.92	mg	Each
Ianufacturing Proccess Inf	ormation												
Terminal Plating / Grid Array Material Term		Ferminal Base A	Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature Ma		erature Ma	x Time at Peak	Temperatu	re Numbe	er of Reflow Cyc	les
Matte Tin (Sn) - anneale	d	CU Alloy		NA		0	C	30		second	s 3		
omments													
or more information regarding m	aterial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10330.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		3615.5	mg
			Supplier	РВТ	26062-94-2		6714.4995	mg
Case Lid	6690.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		2341.5	mg
			Supplier	PBT	26062-94-2		4348.5	mg
DBC	17490.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		6996	mg
			Supplier	Copper (Cu)	7440-50-8		10494	mg
Die	219.105	mg	Supplier	Silicon (Si)	7440-21-3		219.105	mg
Glue	410.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		41	mg
			Supplier	Miscellaneous	Trade Secret		41	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		328	mg
Heat Sink	123450.0	mg	В	Nickel (Ni)	7440-02-0		1913.475	mg
			Supplier	Copper (Cu)	7440-50-8		121536.5234	mg
Silicone Gel	8400.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		2520	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		5880	mg
Solder Paste	5040.0	mg	Supplier	Silver (Ag)	7440-22-4		327.6	mg
			Supplier	Tin (Sn)	7440-31-5		4712.3999	mg
			Supplier	Copper (Cu)	7440-50-8		-151.2004	mg
Terminal	3540.0	mg	Supplier	Silicon (Si)	7440-21-3		9.558	mg
			В	Nickel (Ni)	7440-02-0		47.79	mg
			Supplier	Copper (Cu)	7440-50-8		3481.7671	mg
			Supplier	Phosphorus (P)	7723-14-0		0.885	mg
Thermistor	4.819	mg	Supplier	Copper chromite black spinel	68186-91-4		0.0193	mg
			Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.0087	mg
			Supplier	Silver (Ag)	7440-22-4		0.0805	mg
			Supplier	Boron Trioxide (B2O3)	1303-86-2		0.0183	mg
			Supplier	Tin (Sn)	7440-31-5		0.1108	mg
			А	Lead Oxide (PbO)	1317-36-8		0.1258	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		0.0024	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0386	mg
			Supplier	Misc.	Proprietary Data		0.0954	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0043	mg

			Supplier	Barium Monoxide (BaO)	1304-28-5	0.0019	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1	4.0735	mg
			Supplier	Ruthenium Oxide (RuO2)	12036-10-1	0.0014	mg
			В	Nickel (Ni)	7440-02-0	0.1359	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1	0.0043	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7	0.0092	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7	0.0887	mg
Wire Bond - Al	39.0	mg	Supplier	Aluminum (Al)	7429-90-5	39	mg